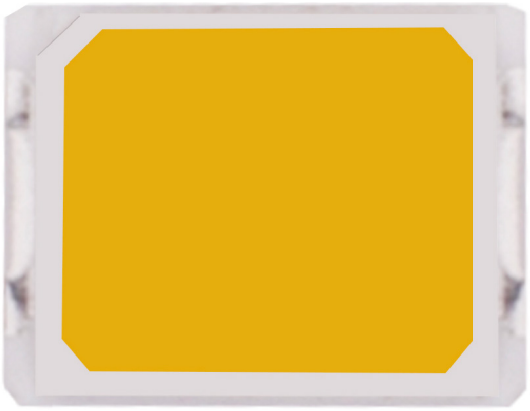


Bridgelux® SMD 2835 0.5W 3V

Product Data Sheet DS221

Introduction

SMD 2835



Features

- Industry-standard 2835 footprint
- Enables 3- and 6-step MacAdam ellipse custom binning kits
- RoHS compliant and lead free
- Multiple CCT configurations for a wide range of lighting applications

Benefits

- Lower operating and manufacturing cost
- Ease of design and rapid go-to-market
- Uniform, consistent white light
- Reliable and constant white point
- Compliant with environmental standards
- Design flexibility

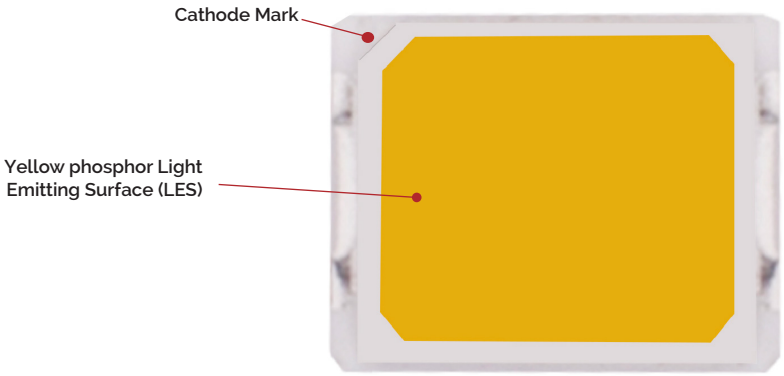
Pb free RoHS

Contents

Product Feature Map	2
Product Nomenclature	2
Product Selection Guide	3
Performance at Commonly Used Drive Currents	5
Electrical Characteristics	8
Absolute Maximum Ratings	9
Product Bin Definitions	10
Performance Curves	13
Typical Radiation Pattern	16
Typical Color Spectrum	17
Mechanical Dimensions	18
Reliability	19
Reflow Characteristics	20
Packaging	21
Design Resources	23
Precautions	23
Disclaimers	23
About Bridgelux	24

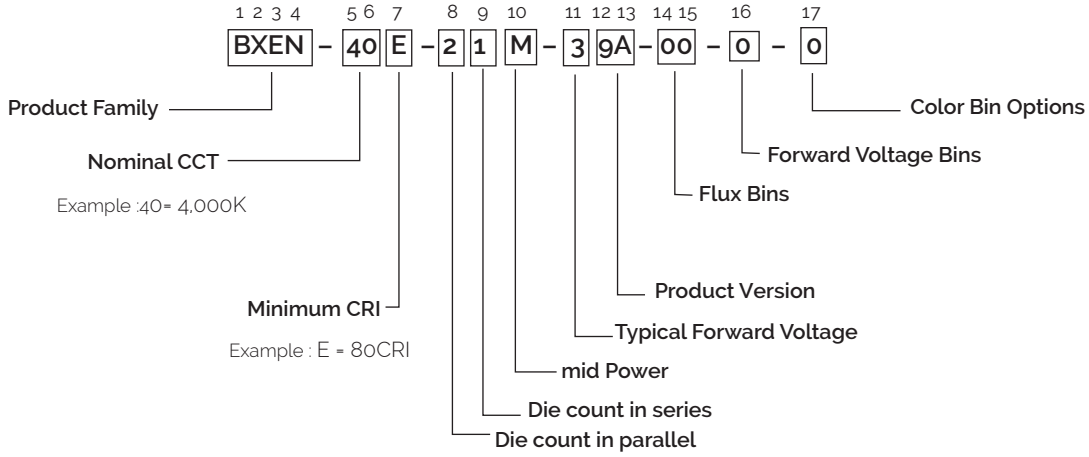
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 2835 is explained as follows:



Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 150mA (T_j=T_{sp}=25˚C)

Part Number[1,6]	Nominal CCT[2] (K)	CRI[3, 5]	Nominal Drive Current (mA)	Forward Voltage[4, 5] (V)			Typical Pulsed Flux (lm)[4, 5]	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEN-22E-21M-39A-00-0-0	2200	80	150	2.80	3.00	3.20	57.0	0.5	127
BXEN-22G-21M-39A-00-0-0	2200	90	150	2.80	3.00	3.20	49.0	0.5	109
BXEN-27E-21M-39A-00-0-0	2700	80	150	2.80	3.00	3.20	65.4	0.5	145
BXEN-27G-21M-39A-00-0-0	2700	90	150	2.80	3.00	3.20	56.2	0.5	125
BXEN-30E-21M-39A-00-0-0	3000	80	150	2.80	3.00	3.20	67.3	0.5	150
BXEN-30G-21M-39A-00-0-0	3000	90	150	2.80	3.00	3.20	57.9	0.5	129
BXEN-35E-21M-39A-00-0-0	3500	80	150	2.80	3.00	3.20	67.3	0.5	150
BXEN-35G-21M-39A-00-0-0	3500	90	150	2.80	3.00	3.20	57.9	0.5	129
BXEN-40E-21M-39A-00-0-0	4000	80	150	2.80	3.00	3.20	71.8	0.5	160
BXEN-40G-21M-39A-00-0-0	4000	90	150	2.80	3.00	3.20	61.8	0.5	137
BXEN-49E-21M-39A-00-0-0	4900	80	150	2.80	3.00	3.20	71.8	0.5	160
BXEN-49G-21M-39A-00-0-0	4900	90	150	2.80	3.00	3.20	61.8	0.5	137
BXEN-50E-21M-39A-00-0-0	5000	80	150	2.80	3.00	3.20	71.8	0.5	160
BXEN-50G-21M-39A-00-0-0	5000	90	150	2.80	3.00	3.20	61.8	0.5	137
BXEN-57E-21M-39A-00-0-0	5700	80	150	2.80	3.00	3.20	71.8	0.5	160
BXEN-57G-21M-39A-00-0-0	5700	90	150	2.80	3.00	3.20	61.8	0.5	137
BXEN-65E-21M-39A-00-0-0	6500	80	150	2.80	3.00	3.20	71.1	0.5	158
BXEN-65G-21M-39A-00-0-0	6500	90	150	2.80	3.00	3.20	61.1	0.5	136

Table 2: Selection Guide, Pulsed Test Performance (T_{sp} = 85˚C)

Part Number[1,6]	Nominal CCT[2] (K)	CRI[3, 5]	Nominal Drive Current (mA)	Forward Voltage[5] (V)			Typical Pulsed Flux (lm)[5]	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEN-22E-21M-39A-00-0-0	2200	80	150	2.74	2.94	3.14	51.2	0.4	116
BXEN-22G-21M-39A-00-0-0	2200	90	150	2.74	2.94	3.14	44.0	0.4	100
BXEN-27E-21M-39A-00-0-0	2700	80	150	2.74	2.94	3.14	58.8	0.4	133
BXEN-27G-21M-39A-00-0-0	2700	90	150	2.74	2.94	3.14	50.5	0.4	115
BXEN-30E-21M-39A-00-0-0	3000	80	150	2.74	2.94	3.14	60.5	0.4	137
BXEN-30G-21M-39A-00-0-0	3000	90	150	2.74	2.94	3.14	52.0	0.4	118
BXEN-35E-21M-39A-00-0-0	3500	80	150	2.74	2.94	3.14	60.5	0.4	137
BXEN-35G-21M-39A-00-0-0	3500	90	150	2.74	2.94	3.14	52.0	0.4	118
BXEN-40E-21M-39A-00-0-0	4000	80	150	2.74	2.94	3.14	64.5	0.4	146
BXEN-40G-21M-39A-00-0-0	4000	90	150	2.74	2.94	3.14	55.5	0.4	126
BXEN-49E-21M-39A-00-0-0	4900	80	150	2.74	2.94	3.14	64.5	0.4	146
BXEN-49G-21M-39A-00-0-0	4900	90	150	2.74	2.94	3.14	55.5	0.4	126
BXEN-50E-21M-39A-00-0-0	5000	80	150	2.74	2.94	3.14	64.5	0.4	146
BXEN-50G-21M-39A-00-0-0	5000	90	150	2.74	2.94	3.14	55.5	0.4	126
BXEN-57E-21M-39A-00-0-0	5700	80	150	2.74	2.94	3.14	64.5	0.4	146
BXEN-57G-21M-39A-00-0-0	5700	90	150	2.74	2.94	3.14	55.5	0.4	126
BXEN-65E-21M-39A-00-0-0	6500	80	150	2.74	2.94	3.14	63.9	0.4	145
BXEN-65G-21M-39A-00-0-0	6500	90	150	2.74	2.94	3.14	54.9	0.4	125

Product Selection Guide

Notes for Tables 1 & 2:

1. The last 6 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and color bin.
   Example: BXEN-40E-21M-39A-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 4000K 6-step ANSI standard chromaticity region with a typical of 80CRI, 2x1 die configuration, mid power, 3.0V typical forward voltage.
2. Product CCT is cold targeted at Tsp = 25°C for CRI 80, and hot targeted at Tsp = 85°C for CRI 90. Nominal CCT as defined by ANSI C78.377-2011.
3. Listed CRIs are typical values.
4. Products tested under pulsed condition (10ms pulse width) at nominal drive current .
5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.15V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 2835.
6. Refer to Table 6 and Table 7 for Bridgelux SMD 2835 Luminous Flux Binning and Forward Voltage Binning information.
7. Typical pulsed test performance values are provided as reference only and are not a guarantee of performance.
8. Typical performance is estimated based on operation under pulsed current with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 25°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and the exposed environment to which the product is subjected.

Performance at Commonly Used Drive Currents

SMD 2835 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 2835 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current[1] (mA)	Typical V_f T_{sp} = 25°C (V)	Typical Power T_{sp} = 25°C (W)	Typical Pulsed Flux[2] T_{sp} = 25°C (lm)	Typical Pulsed Flux[2] T_{sp} = 85°C (lm)	Typical Efficacy T_{sp} = 25°C (lm/W)
BXEN-22E-21M-39A-00-0-0	80	30	2.71	0.1	13.1	11.7	160
		42	2.75	0.1	18.1	16.2	156
		65	2.82	0.2	27.1	24.3	148
		90	2.88	0.3	36.5	32.8	141
		120	2.94	0.4	47.1	42.3	133
		150	**3.00**	**0.5**	**57.0**	**51.2**	**127**
BXEN-22G-21M-39A-00-0-0	90	30	2.71	0.1	11.2	10.1	138
		42	2.75	0.1	15.5	14.0	134
		65	2.82	0.2	23.3	20.9	127
		90	2.88	0.3	31.4	28.2	121
		120	2.94	0.4	40.5	36.4	115
		150	**3.00**	**0.5**	**49.0**	**44.0**	**109**
BXEN-27E-21M-39A-00-0-0	80	30	2.71	0.1	15.0	13.5	184
		42	2.75	0.1	20.7	18.6	179
		65	2.82	0.2	31.1	27.9	169
		90	2.88	0.3	41.9	37.7	162
		120	2.94	0.4	54.1	48.6	153
		150	**3.00**	**0.5**	**65.4**	**58.8**	**145**
BXEN-27G-21M-39A-00-0-0	90	30	2.71	0.1	12.9	11.6	158
		42	2.75	0.1	17.8	16.0	154
		65	2.82	0.2	26.7	24.0	146
		90	2.88	0.3	36.0	32.4	139
		120	2.94	0.4	46.4	41.7	132
		150	**3.00**	**0.5**	**56.2**	**50.5**	**125**
BXEN-30E-21M-39A-00-0-0	80	30	2.71	0.1	15.4	13.9	189
		42	2.75	0.1	21.3	19.2	184
		65	2.82	0.2	32.0	28.7	174
		90	2.88	0.3	43.1	38.7	166
		120	2.94	0.4	55.6	50.0	158
		150	**3.00**	**0.5**	**67.3**	**60.5**	**150**
BXEN-30G-21M-39A-00-0-0	90	30	2.71	0.1	13.3	11.9	163
		42	2.75	0.1	18.4	16.5	159
		65	2.82	0.2	27.5	24.7	150
		90	2.88	0.3	37.1	33.3	143
		120	2.94	0.4	47.9	43.0	136
		150	**3.00**	**0.5**	**57.9**	**52.0**	**129**

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current[1] (mA)	Typical V_f T_{sp} = 25°C (V)	Typical Power T_{sp} = 25°C (W)	Typical Pulsed Flux[2] T_{sp} = 25°C (lm)	Typical Pulsed Flux[2] T_{sp} = 85°C (lm)	Typical Efficacy T_{sp} = 25°C (lm/W)
BXEN-35E-21M-39A-00-0-0	80	30	2.71	0.1	15.4	13.9	189
		42	2.75	0.1	21.3	19.2	184
		65	2.82	0.2	32.0	28.7	174
		90	2.88	0.3	43.1	38.7	166
		120	2.94	0.4	55.6	50.0	158
		150	**3.00**	**0.5**	**67.3**	**60.5**	**150**
BXEN-35G-21M-39A-00-0-0	90	30	2.71	0.1	13.3	11.9	163
		42	2.75	0.1	18.4	16.5	159
		65	2.82	0.2	27.5	24.7	150
		90	2.88	0.3	37.1	33.3	143
		120	2.94	0.4	47.9	43.0	136
		150	**3.00**	**0.5**	**57.9**	**52.0**	**129**
BXEN-40E-21M-39A-00-0-0	80	30	2.71	0.1	16.4	14.8	202
		42	2.75	0.1	22.8	20.5	197
		65	2.82	0.2	34.1	30.6	186
		90	2.88	0.3	46.0	41.3	178
		120	2.94	0.4	59.3	53.3	168
		150	**3.00**	**0.5**	**71.8**	**64.5**	**160**
BXEN-40G-21M-39A-00-0-0	90	30	2.71	0.1	14.2	12.7	174
		42	2.75	0.1	19.6	17.6	169
		65	2.82	0.2	29.4	26.4	160
		90	2.88	0.3	39.6	35.6	153
		120	2.94	0.4	51.1	45.9	145
		150	**3.00**	**0.5**	**61.8**	**55.5**	**137**
BXEN-49E-21M-39A-00-0-0	80	30	2.71	0.1	16.4	14.8	202
		42	2.75	0.1	22.8	20.5	197
		65	2.82	0.2	34.1	30.6	186
		90	2.88	0.3	46.0	41.3	178
		120	2.94	0.4	59.3	53.3	168
		150	**3.00**	**0.5**	**71.8**	**64.5**	**160**
BXEN-49G-21M-39A-00-0-0	90	30	2.71	0.1	14.2	12.7	174
		42	2.75	0.1	19.6	17.6	169
		65	2.82	0.2	29.4	26.4	160
		90	2.88	0.3	39.6	35.6	153
		120	2.94	0.4	51.1	45.9	145
		150	**3.00**	**0.5**	**61.8**	**55.5**	**137**

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current[1] (mA)	Typical V_f T_{sp} = 25˚C (V)	Typical Power T_{sp} = 25˚C (W)	Typical Pulsed Flux[2] T_{sp} = 25˚C (lm)	Typical Pulsed Flux[2] T_{sp} = 85˚C (lm)	Typical Efficacy T_{sp} = 25˚C (lm/W)
BXEN-50E-21M-39A-00-0-0	80	30	2.71	0.1	16.4	14.8	202
		42	2.75	0.1	22.8	20.5	197
		65	2.82	0.2	34.1	30.6	186
		90	2.88	0.3	46.0	41.3	178
		120	2.94	0.4	59.3	53.3	168
		150	**3.00**	**0.5**	**71.8**	**64.5**	**160**
BXEN-50G-21M-39A-00-0-0	90	30	2.71	0.1	14.2	12.7	174
		42	2.75	0.1	19.6	17.6	169
		65	2.82	0.2	29.4	26.4	160
		90	2.88	0.3	39.6	35.6	153
		120	2.94	0.4	51.1	45.9	145
		150	**3.00**	**0.5**	**61.8**	**55.5**	**137**
BXEN-57E-21M-39A-00-0-0	80	30	2.71	0.1	16.4	14.8	202
		42	2.75	0.1	22.8	20.5	197
		65	2.82	0.2	34.1	30.6	186
		90	2.88	0.3	46.0	41.3	178
		120	2.94	0.4	59.3	53.3	168
		150	**3.00**	**0.5**	**71.8**	**64.5**	**160**
BXEN-57G-21M-39A-00-0-0	90	30	2.71	0.1	14.2	12.7	174
		42	2.75	0.1	19.6	17.6	169
		65	2.82	0.2	29.4	26.4	160
		90	2.88	0.3	39.6	35.6	153
		120	2.94	0.4	51.1	45.9	145
		150	**3.00**	**0.5**	**61.8**	**55.5**	**137**
BXEN-65E-21M-39A-00-0-0	80	30	2.71	0.1	16.3	14.6	200
		42	2.75	0.1	22.5	20.3	195
		65	2.82	0.2	33.8	30.3	184
		90	2.88	0.3	45.6	40.9	176
		120	2.94	0.4	58.8	52.8	166
		150	**3.00**	**0.5**	**71.1**	**63.9**	**158**
BXEN-65G-21M-39A-00-0-0	90	30	2.71	0.1	14.0	12.6	172
		42	2.75	0.1	19.4	17.4	167
		65	2.82	0.2	29.0	26.1	158
		90	2.88	0.3	39.2	35.2	151
		120	2.94	0.4	50.5	45.4	143
		150	**3.00**	**0.5**	**61.1**	**54.9**	**136**

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
3. Typical stabilized pulsed performance values are provided as reference only and are not a guarantee of performance.

Electrical Characteristics

Table 4: Electrical Characteristics

Part Number	Drive Current (mA)	Forward Voltage (V) [1,2]			Typical Temperature Coefficient of Forward Voltage $\Delta V_f/\Delta T$ (mV/°C)	Typical Thermal Resistance Junction to Solder Point[3] $R_{j\text{-}sp}$ (°C/W)
		Minimum	Typical	Maximum		
BXEN-XXX-21M-39A-00-0-0	150	2.8	3.0	3.2	-1.01	19

Notes for Table 4:

1. Bridgelux maintains a tolerance of ± 0.15V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.
2. Products tested under pulsed condition (10ms pulse width) at nominal drive current where Tsp = 25˚C.
3. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating
LED Junction Temperature (T_j)	125˚C
Storage Temperature	-40˚C to +105˚C
Operating Solder Point Temperature (T_{Sp})	-40˚C to +105˚C
Soldering Temperature	260˚C or lower for a maximum of 10 seconds
Maximum Drive Current	240mA
Maximum Peak Pulsed Forward Current[1]	480mA
Maximum Reverse Voltage[2]	-
Moisture Sensitivity Rating	MSL 3
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012

Notes for Table 5:

1. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.
2. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. no rating is provided.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 2835 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 150mA, T_{sp}=25˚C

Bin Code	Minimum	Maximum	Unit	Condition
29	45	50	lm	I_F=150mA
2A	50	55		
2B	55	60		
2C	60	65		
2D	65	70		
2E	70	75		
2F	75	80		

Note for Table 6:

1. Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

Table 7: Forward Voltage Bin Definition at 150mA, T_{sp}=25˚C

Bin Code	Minimum	Maximum	Unit	Condition
A	2.8	2.9	V	I_F=150mA
B	2.9	3.0		
C	3.0	3.1		
D	3.1	3.2		

Note for Table 7:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.

Product Bin Definitions

Table 8: MacAdam Ellipse Color Bin Definitions

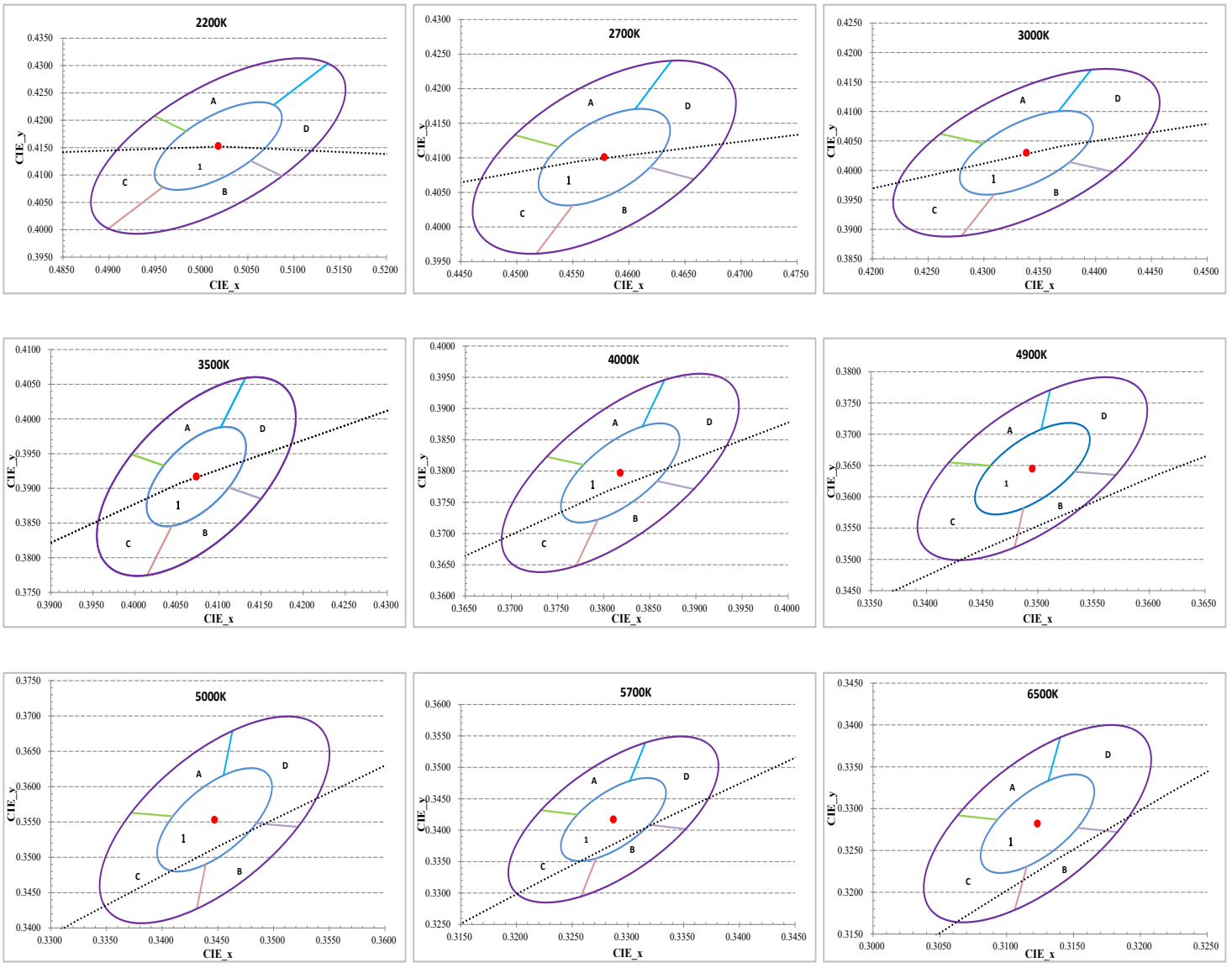
CCT	Color Space	Center Point		Major Axis	Minor Axis	Ellipse Rotation Angle	Color Bin
		X	Y				
2200K	3 SDCM	0.5018	0.4153	0.00960	0.00441	51.67	1
	6 SDCM	0.5018	0.4153	0.01920	0.00882	51.67	1/A/B/C/D
2700K	3 SDCM	0.4578	0.4101	0.00810	0.00420	53.70	1
	6 SDCM	0.4578	0.4101	0.01620	0.00840	53.70	1/A/B/C/D
3000K	3 SDCM	0.4338	0.4030	0.00834	0.00408	53.22	1
	6 SDCM	0.4338	0.4030	0.01668	0.00816	53.22	1/A/B/C/D
3500K	3 SDCM	0.4078	0.3930	0.00834	0.00408	54.00	1
	6 SDCM	0.4078	0.3930	0.01668	0.00816	54.00	1/A/B/C/D
4000K	3 SDCM	0.3818	0.3797	0.00939	0.00402	53.72	1
	6 SDCM	0.3818	0.3797	0.01878	0.00804	53.72	1/A/B/C/D
4900K	3 SDCM	0.3495	0.3645	0.00822	0.00354	59.62	1
	6 SDCM	0.3495	0.3645	0.01644	0.00708	59.62	1/A/B/C/D
5000K	3 SDCM	0.3447	0.3553	0.00822	0.00354	59.62	1
	6 SDCM	0.3447	0.3553	0.01644	0.00708	59.62	1/A/B/C/D
5700K	3 SDCM	0.3287	0.3417	0.00746	0.00320	59.09	1
	6 SDCM	0.3287	0.3417	0.01492	0.00640	59.09	1/A/B/C/D
6500K	3 SDCM	0.3123	0.3282	0.00669	0.00285	58.57	1
	6 SDCM	0.3123	0.3282	0.01338	0.0057	58.57	1/A/B/C/D

Notes for Table 8:

1. Color binning at T_{sp}=25˚C for CRI 80 and T_{sp}=85˚C for CRI 90 unless otherwise specified
2. Bridgelux maintains a tolerance of ± 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (5 Color Bin Structure, CRI 80 at T_{sp}=25˚C, CRI 90 at T_{sp}=85˚C)



Performance Curves

Figure 2: Drive Current vs. Forward Voltage (T_{sp}=25˚C)

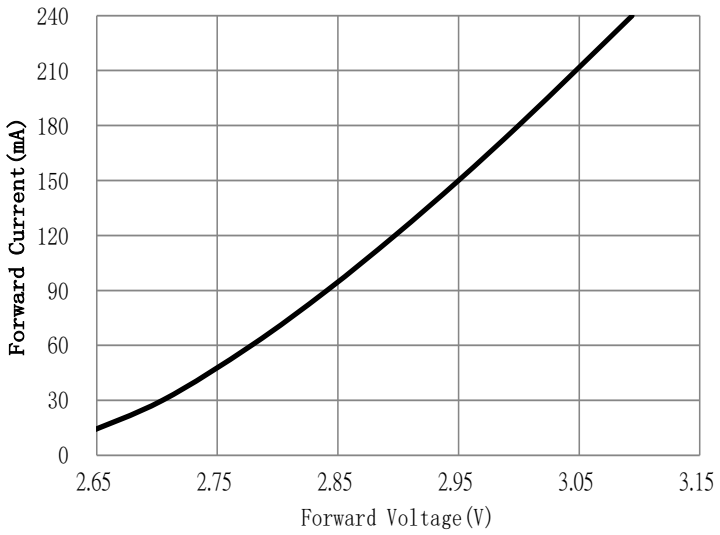
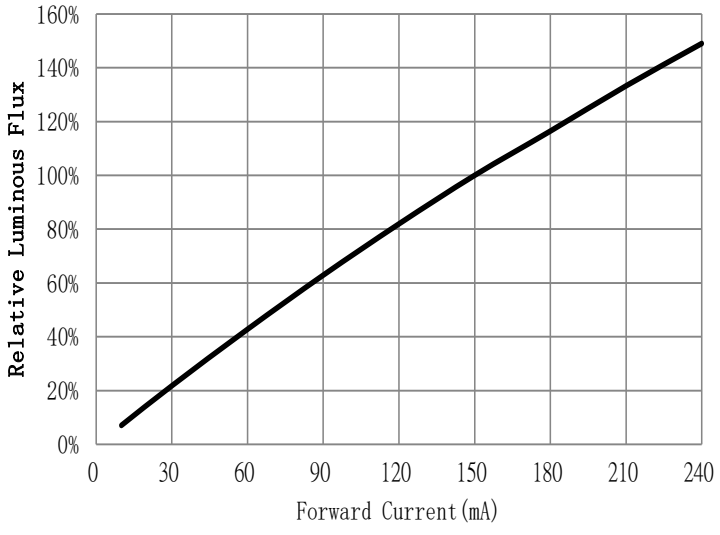


Figure 3: Relative Luminous Flux vs. Forward Current (T_{sp}=25˚C)



Note for Figure 3:

1. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Relative Flux vs. Solder Point Temperature

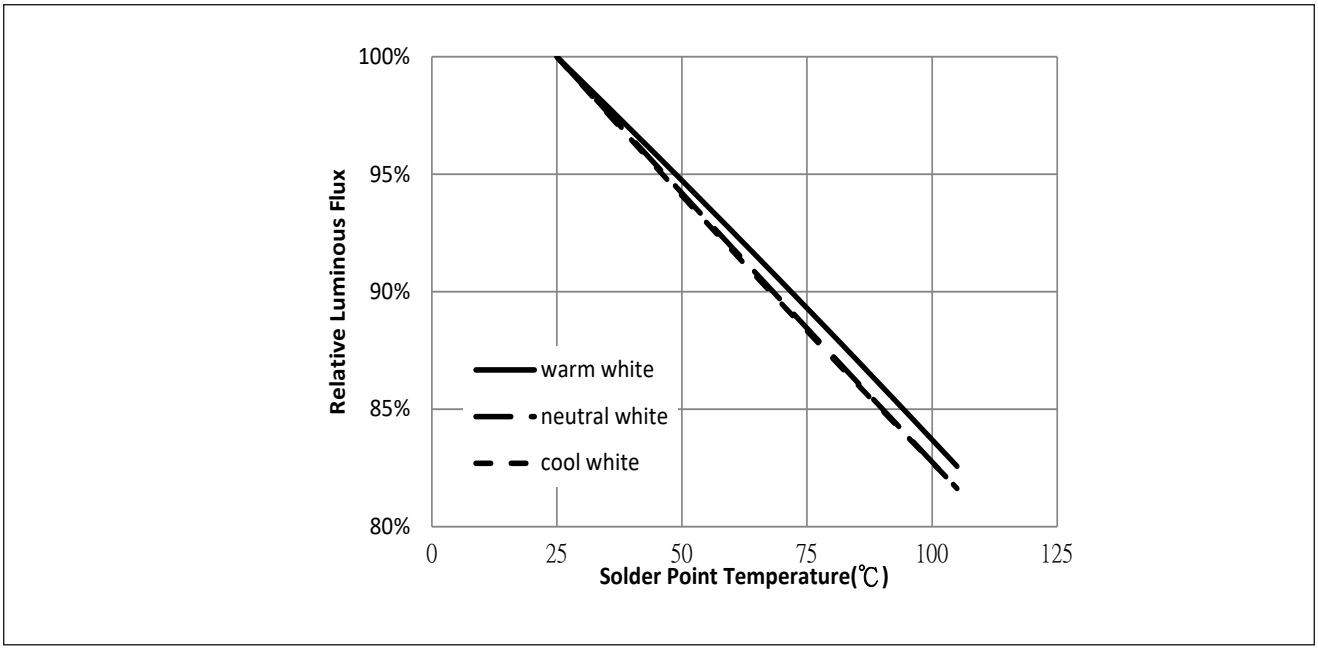
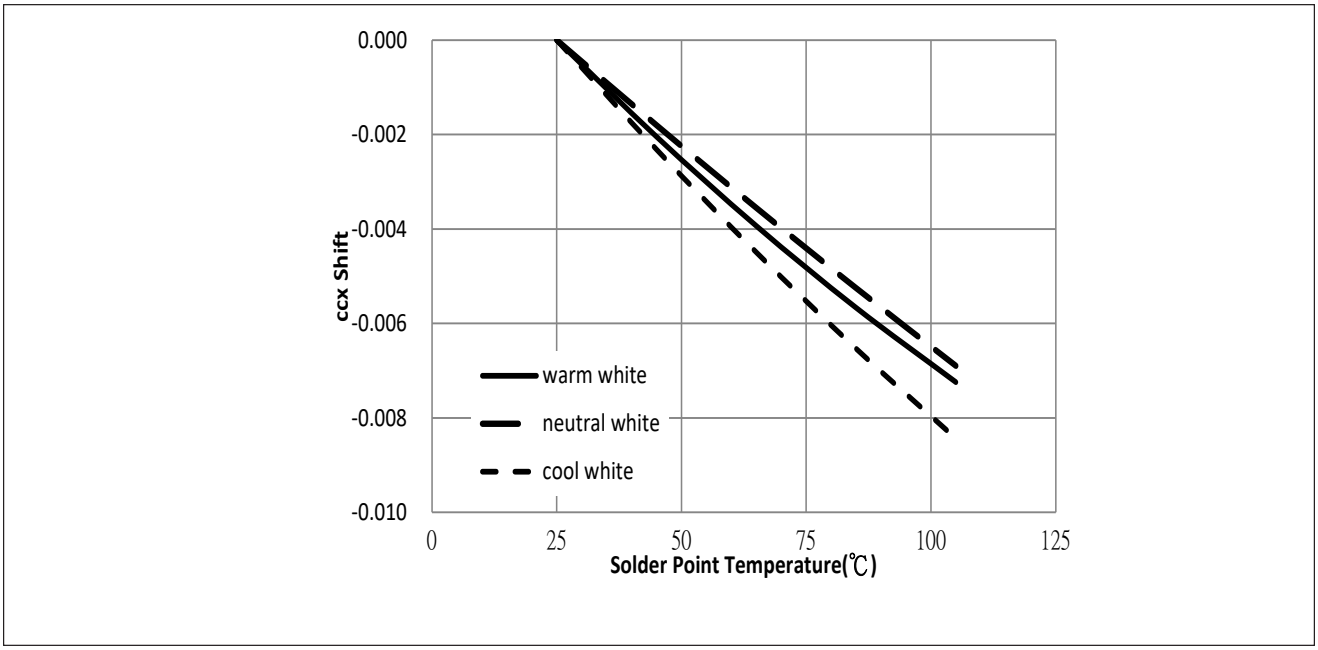


Figure 5: Typical ccx Shift vs. Solder Point Temperature

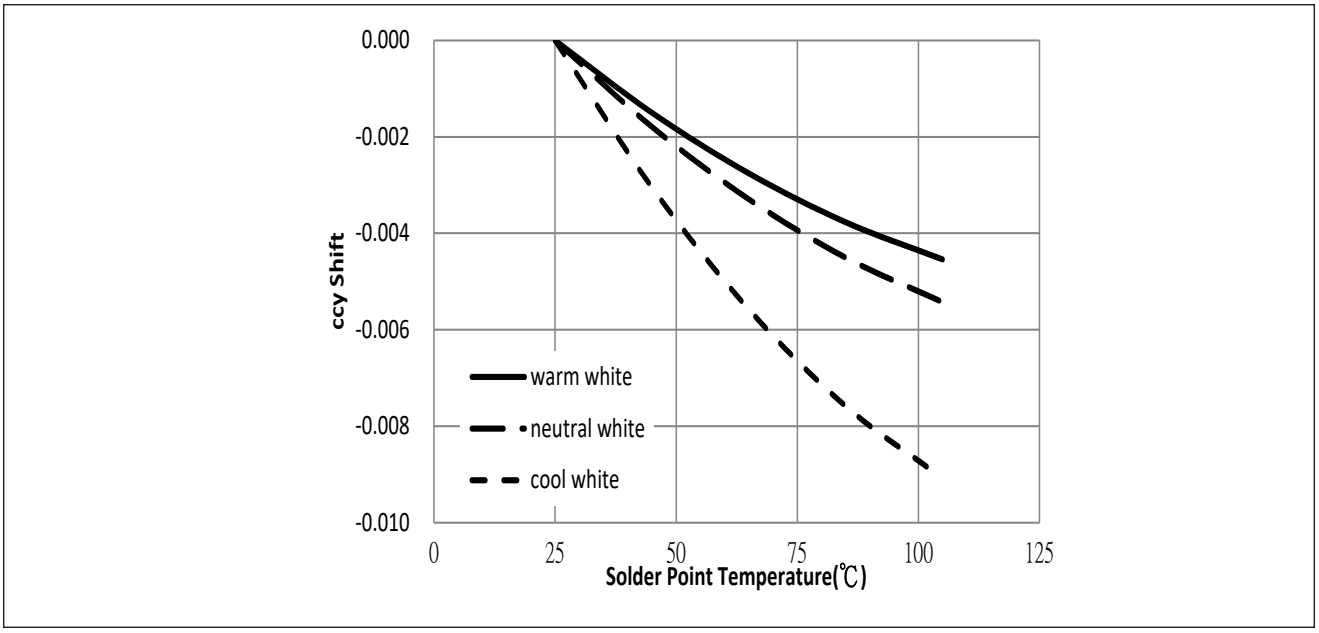


Notes for Figures 4 & 5:

1. Characteristics shown for warm white based on 3000K and 80 CRI.
2. Characteristics shown for neutral white based on 4000K and 80 CRI.
3. Characteristics shown for cool white based on 6500K and 80 CRI.
4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information

Performance Curves

Figure 6: Typical ccy Shift vs. Solder Point Temperature

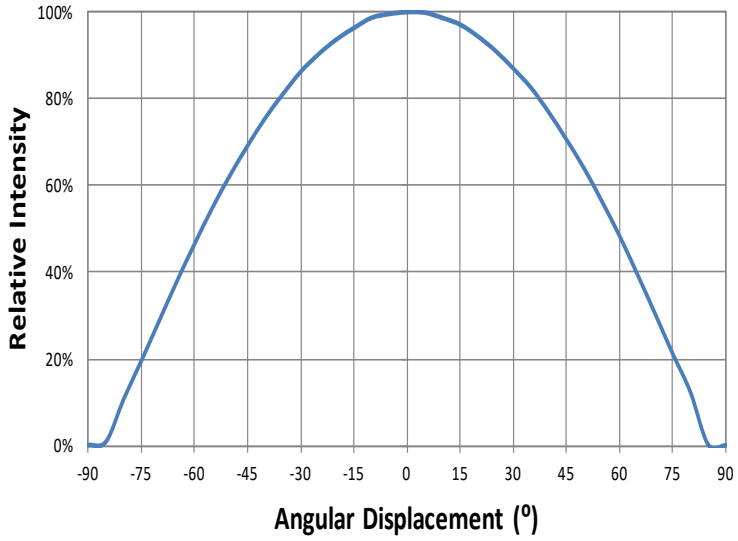


Notes for Figure 6:

1. Characteristics shown for warm white based on 3000K and 80 CRI.
2. Characteristics shown for neutral white based on 4000K and 80 CRI.
3. Characteristics shown for cool white based on 6500K and 80 CRI.
4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Typical Radiation Pattern

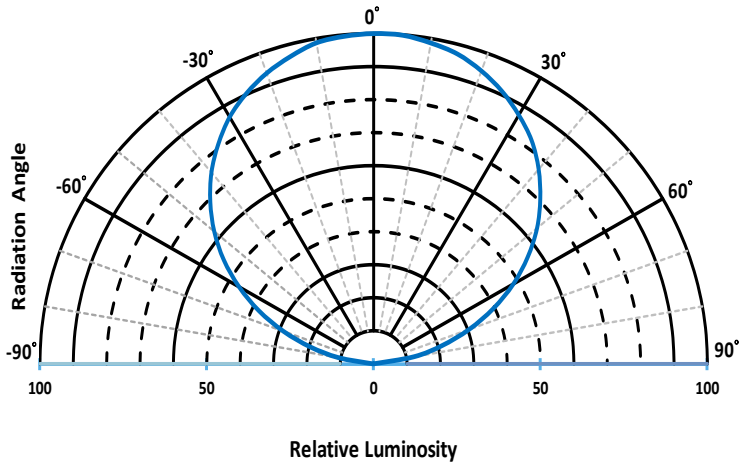
Figure 7: Typical Spatial Radiation Pattern at 150mA, T_{sp}=25°C



Notes for Figure 7:

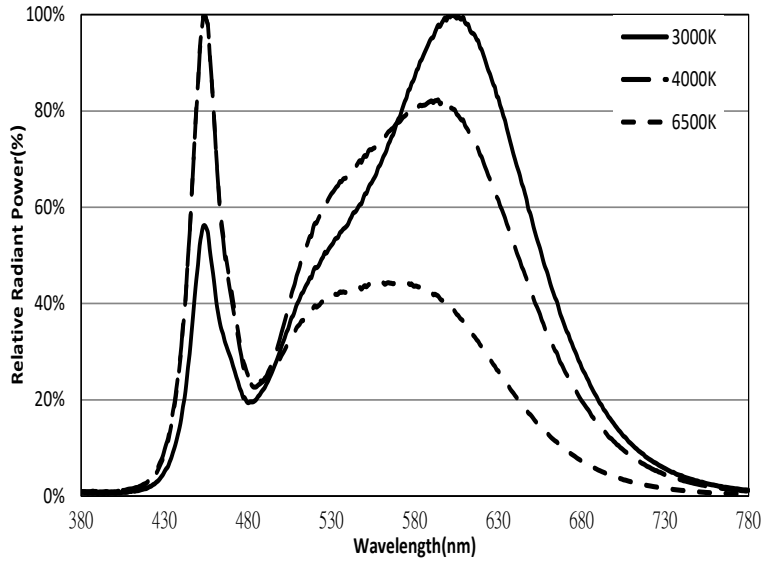
1. Typical viewing angle is 120°.
2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is ½ of the peak value.

Figure 8: Typical Polar Radiation Pattern at 150mA, T_{sp}=25°C



Typical Color Spectrum

Figure 9: Typical Color Spectrum

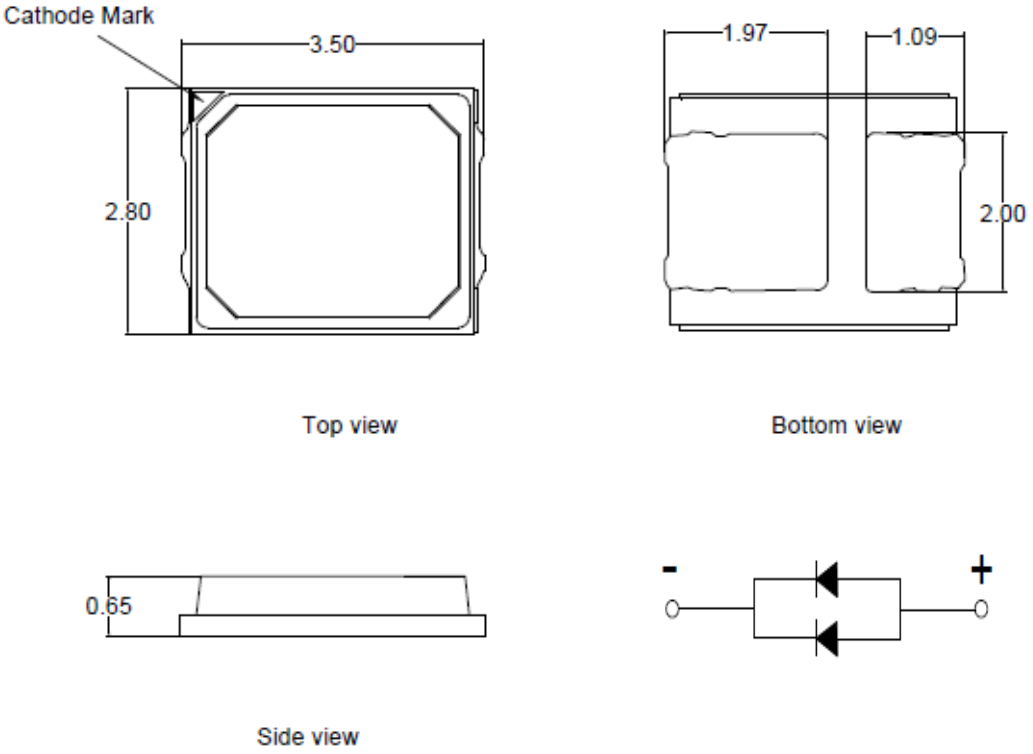


Notes for Figure 9:

1. Color spectra measured at nominal current for Tsp = 25°C
2. Color spectra shown for 80 CRI products.

Mechanical Dimensions

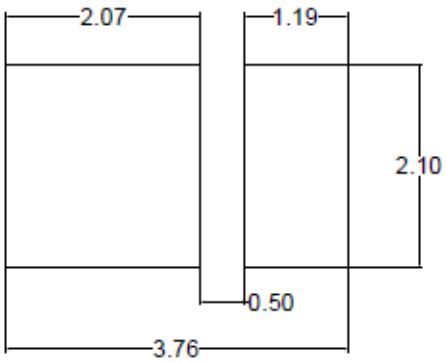
Figure 10: Drawing for SMD 2835



Notes for Figure 10:

1. Drawings are not to scale.
2. Drawing dimensions are in millimeters.
3. Unless otherwise specified, tolerances are ± 0.10mm.

Recommended PCB Soldering Pad Pattern



Reliability

Table 9: Reliability Test Items and Conditions

No .	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/Reflow Sensitivity	J-STD-020E	T_{sld} = 260°C, 10sec, Precondition: 60°C, 60%RH, 168hr	-	3 reflows	0/20
2	Low Temperature Storage	JESD22-A119	T_a=-40°C	-	1000 hours	0/20
3	High Temperature Storage	JESD22-A103D	T_a= 100°C	-	1000 hours	0/20
4	Low Temperature Operating Life	JESD22-A108D	T_a=-40°C	150mA	1000 hours	0/20
5	Temperature Humidity Operating Life	JESD22-A101C	T_{sp}=85°C, RH=85%	150mA	1000 hours	0/20
6	High Temperature Operating Life	JESD22-A108D	T_{sp}=85°C	240mA	1000 hours	0/20
7	Thermal Shock	JESD22-A106B	T_a=-40°C ~100°C; Dwell : 15min; Transfer: 10sec	-	200 cycles	0/20
8	Temperature Cycle	JESD22-A104E	T_a=-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min	-	200 cycles	0/20
9	Electrostatic Discharge	JS-001-2012	HBM, 2KV, 1.5kΩ, 100pF, Alternately positive or negative	-	-	0/20

Passing Criteria

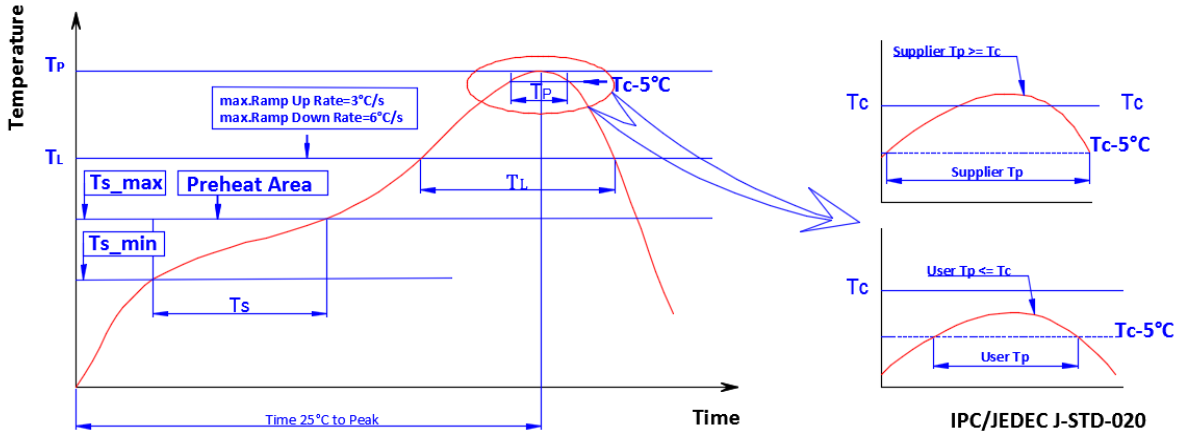
Item	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	150mA	ΔVf<10%
Luminous Flux	Fv	150mA	ΔFv<30%
Chromaticity Coordinates	(x, y)	150mA	Δu'v'<0.007

Notes for Table 9:

1. Measurements are performed after allowing the LEDs to return to room temperature
2. T_{sld} : reflow soldering temperature; T_a : ambient temperature

Reflow Characteristics

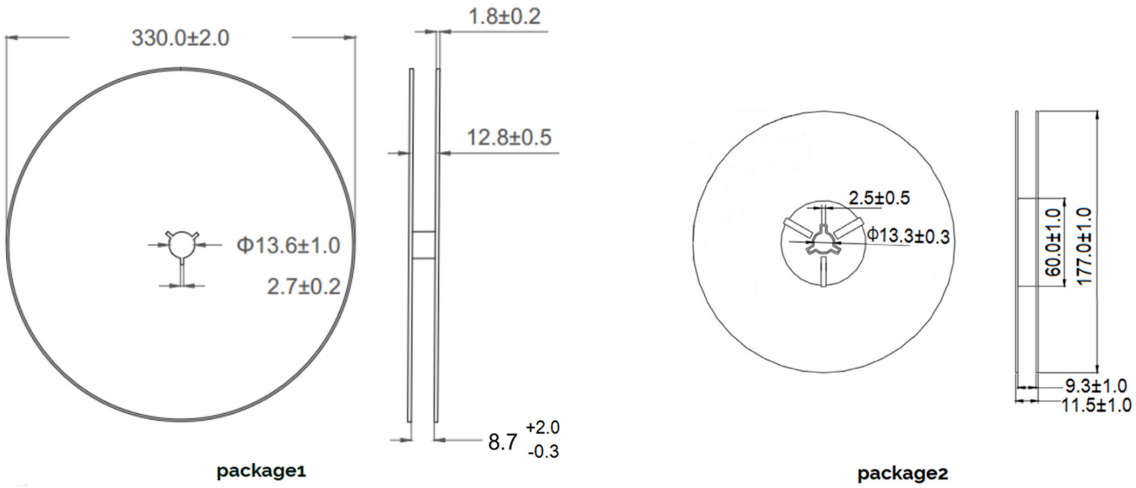
Figure 11 : Reflow Profile (Reflow frequency 2 times max)



Profile Feature	Lead Free Assembly
Temperature Min. (Ts_min)	160˚C
Temperature Max. (Ts_max)	205˚C
Time (ts) from Ts_min to Ts_max	60-150 seconds
Ramp-Up Rate (TL to Tp)	3 ˚C/second
Liquidus Temperature (TL)	220 ˚C
Time (TL) Maintained Above TL	60-150 seconds
Peak Temp(Tp)	260 ˚C max 10 sec
Time (Tp) Within 5 ˚C of the Specified Classification Temperature (Tc)	25 seconds max.
Ramp-Down Rate (Tp to TL)	5 ˚C/second max.
Time 25 ˚C to Peak Temperature	10 minutes max.

Packaging

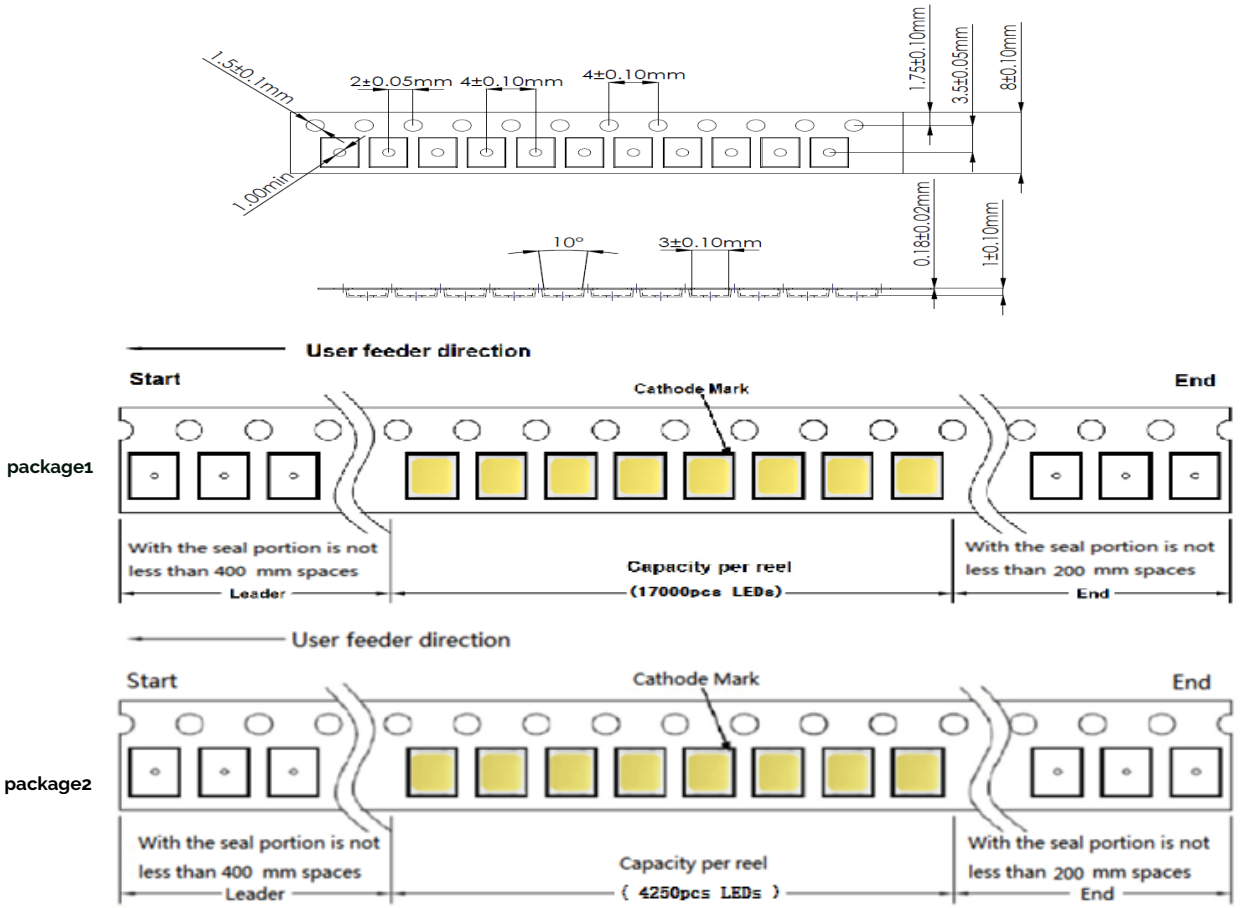
Figure 12: Emitter Reel Drawings



Note for Figure 12:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 13: Emitter Tape Drawings

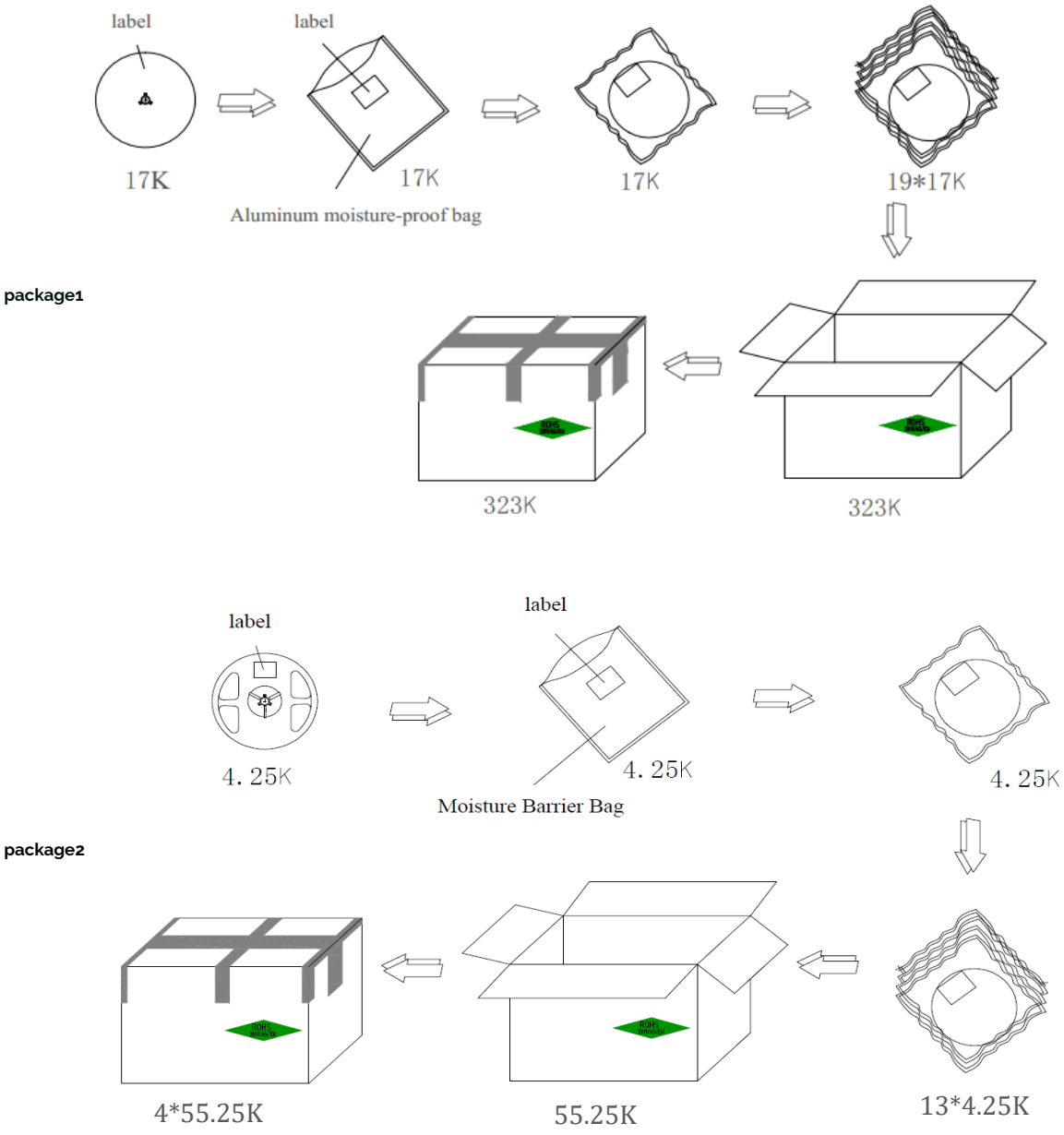


Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 14: Emitter Reel Packaging Drawings



Note for Figure 14:

1. Drawings are not to scale.

Design Resources

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux SMD LED emitter is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. SMD LED emitters are classified as Risk Group 1 when operated at or below the maximum drive current. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: Bridging Light and Life™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

For more information about the company, please visit
bridgelux.com
twitter.com/Bridgelux
facebook.com/Bridgelux
youtube.com/user/Bridgelux
WeChat ID: BridgeluxInChina
https://www.linkedin.com/company/bridgelux-inc-_2

46410 Fremont Boulevard
Fremont, CA 94538 USA
Tel (925) 583-8400
Fax (925) 583-8401
www.bridgelux.com

© 2026 Bridgelux, Inc. All rights reserved 2026. Product specifications are subject to change without notice. Bridgelux and the Bridgelux stylized logo design are registered trademarks of Bridgelux, Inc. All other trademarks are the property of their respective owners.